ON Semiconductor



Title of Change:	NCV7471 Datasheet Update – Revision 4	
Effective date:	17 September 2015	
Contact information:	Contact your local ON Semiconductor Sales Office or <roman.buzas@onsemi.com></roman.buzas@onsemi.com>	
Type of notification:	ON Semiconductor will consider this change accepted.	
Change category:	Wafer Fab Change Assembly Change	Test Change 🛛 Other
Change Sub-Category(s): Manufacturing Site Change Manufacturing Process Cha		 Datasheet/Product Doc change Shipping/Packaging/Marking Other:
Sites Affected:	pplicable ON Semiconductor site(s) :	External Foundry/Subcon site(s)
 Description and Purpose: New component NCV7471A added to the datasheet Marking diagram updated (Page 1) NCV7571A-5 added Figure 5 and Figure 6 added - VOUT Monitoring for NCV7471A (Page 9) New conditions for FSO activation added (Page 27, Table 11) STATUS1 flagFSO.x flags combination for VOUT failure extended (Page 36, Table 22) New Device IDs added: 0x144 or 0x184 for NCV7471A (Page 37) New OPNs added: NCV7471ADQ5R2G (Page 49) Quality and package statements added "NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable" "These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS compliant" New Device ID added (due to new manufacture location) 0x103 or 0x143 for NCV7471 (Page 37) 		
List of Affected Standard Parts: NCV7471DQ5G NCV7471DQ5R2G NCV7471ADQ5R2G		